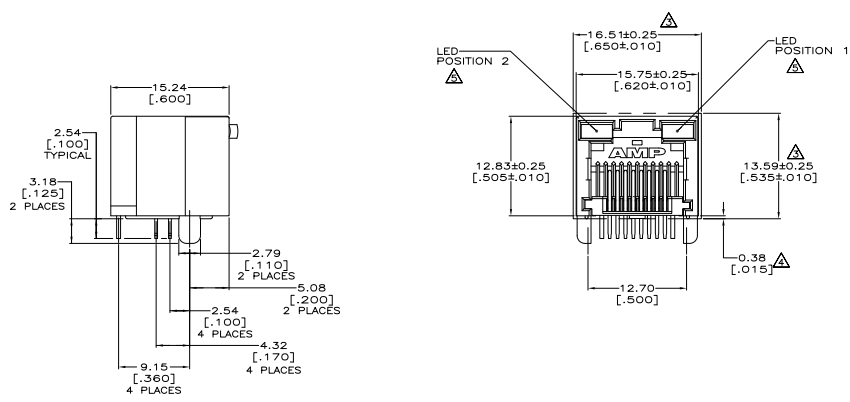
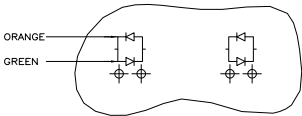


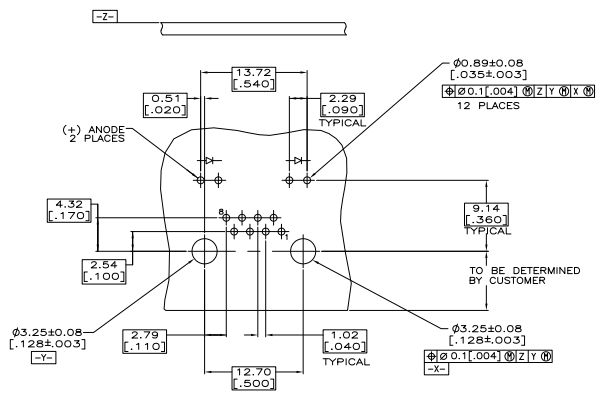
REV	DATE	DESCRIPTION	BY	CHK
AA	22			
A1		REVISED PER ECO-09-024927	DMOVIN	KK AEG



- △ MATERIAL:
 HOUSING - HIGH TEMPERATURE THERMOPLASTIC, BLACK, UL94V-0.
 TERMINALS - 0.38[.014] THICK PHOS BRONZE PLATED WITH 3.8[.00150] MINIMUM THICK MATTE TIN IN SOLDER AREA. 1.27[.00050] MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE TERMINAL PLATED WITH 1.27[.00050] MINIMUM THICK NICKEL.
 LIGHT EMITTING DIODE (LED) - DIFFUSED EPOXY LENS, 0.51 x 0.51[.020 x .020] CARBON STEEL WIREFRAME LEADS PREPLATED WITH 8.89 [0.003500] THICK Sn/Cu OVER 2.03 [0.00080] THICK Ag OVER 1.02[.00040] THICK Cu OVER 3.56 [0.00140] THICK Ni OVER 1.02[.00040] Cu UNDERPLATE.
- 2. JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
- △ SUGGESTED PANEL OPENING DIMENSIONS.
- △ SUGGESTED CLEARANCE BETWEEN BOTTOM OF CONNECTOR AND BOTTOM PANEL OPENING.
- △ SEE TABLE FOR COLOR OF LEDS AND NUMBER REQUIRED.
- 6. THIS MODULAR JACK WITH INTEGRATED LED IS NOT IR REFLOW SOLDERING PROCESS COMPATIBLE.
- △ OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI



LED CURRENT DIAGRAM
5406508-7 ONLY



SUGGESTED PRINTED CIRCUIT BOARD LAYOUT
(COMPONENT SIDE)

INDICATOR	INDICATOR COLOR	PART NUMBER
△	ORANGE/GREEN	5406508-7
△	YELLOW	5406508-6
△	GREEN	5406508-4
△	YELLOW	5406508-3
△	GREEN	5406508-2
△	YELLOW	5406508-1

THIS DRAWING IS A CONTROLLED DOCUMENT.		TYS ELECTRONICS CORPORATION Harrisburg, Pa 17105-3608	
DESIGNER	DATE	REVISED BY	DATE
WESTMAN	108-1163-4	WESTMAN	114-2154
DATE	108-1163-4	DATE	114-2154
REVISED BY	108-1163-4	REVISED BY	114-2154
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